



Gallium Arsenide PHEMT

RF Power Field Effect Transistor

Designed for WLL/MMDS/BWA or UMTS driver applications with frequencies from 500 to 5000 MHz. Device is unmatched and is suitable for use in Class AB Customer Premise Equipment (CPE) applications.

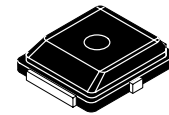
- Typical Single-Carrier W-CDMA Performance: $V_{DD} = 6$ Volts, $I_{DQ} = 180$ mA, $P_{out} = 450$ mWatts Avg., 3550 MHz, Channel Bandwidth = 3.84 MHz, PAR = 8.5 dB @ 0.01% Probability on CCDF.
 Power Gain — 10 dB
 Drain Efficiency — 27%
 ACPR @ 5 MHz Offset — -42.5 dBc in 3.84 MHz Channel Bandwidth
- 3 Watts P1dB @ 3550 MHz, CW

Features

- Excellent Phase Linearity and Group Delay Characteristics
- High Gain, High Efficiency and High Linearity
- RoHS Compliant
- In Tape and Reel. T1 Suffix = 1000 Units per 12 mm, 7 inch Reel.

MRFG35003N6AT1

**3.5 GHz, 3 W, 6 V
 POWER FET
 GaAs PHEMT**



**CASE 466-03, STYLE 1
 PLD-1.5
 PLASTIC**

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|---------------------------|-----------|-------------|------|
| Drain-Source Voltage | V_{DSS} | 8 | Vdc |
| Gate-Source Voltage | V_{GS} | -5 | Vdc |
| RF Input Power | P_{in} | 24 | dBm |
| Storage Temperature Range | T_{stg} | -65 to +150 | °C |
| Channel Temperature (1) | T_{ch} | 175 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value (2) | Unit |
|--------------------------------------|-----------------|-----------|------|
| Thermal Resistance, Junction to Case | $R_{\theta JC}$ | 5.9 | °C/W |

Table 3. ESD Protection Characteristics

| Test Methodology | Class |
|---------------------------------------|--------------|
| Human Body Model (per JESD22-A114) | 2 (Minimum) |
| Machine Model (per EIA/JESD22-A115) | A (Minimum) |
| Charge Device Model (per JESD22-C101) | IV (Minimum) |

Table 4. Moisture Sensitivity Level

| Test Methodology | Rating | Package Peak Temperature | Unit |
|--------------------------------------|--------|--------------------------|------|
| Per JESD22-A113, IPC/JEDEC J-STD-020 | 3 | 260 | °C |

1. For reliable operation, the operating channel temperature should not exceed 150°C.
2. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

Table 5. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

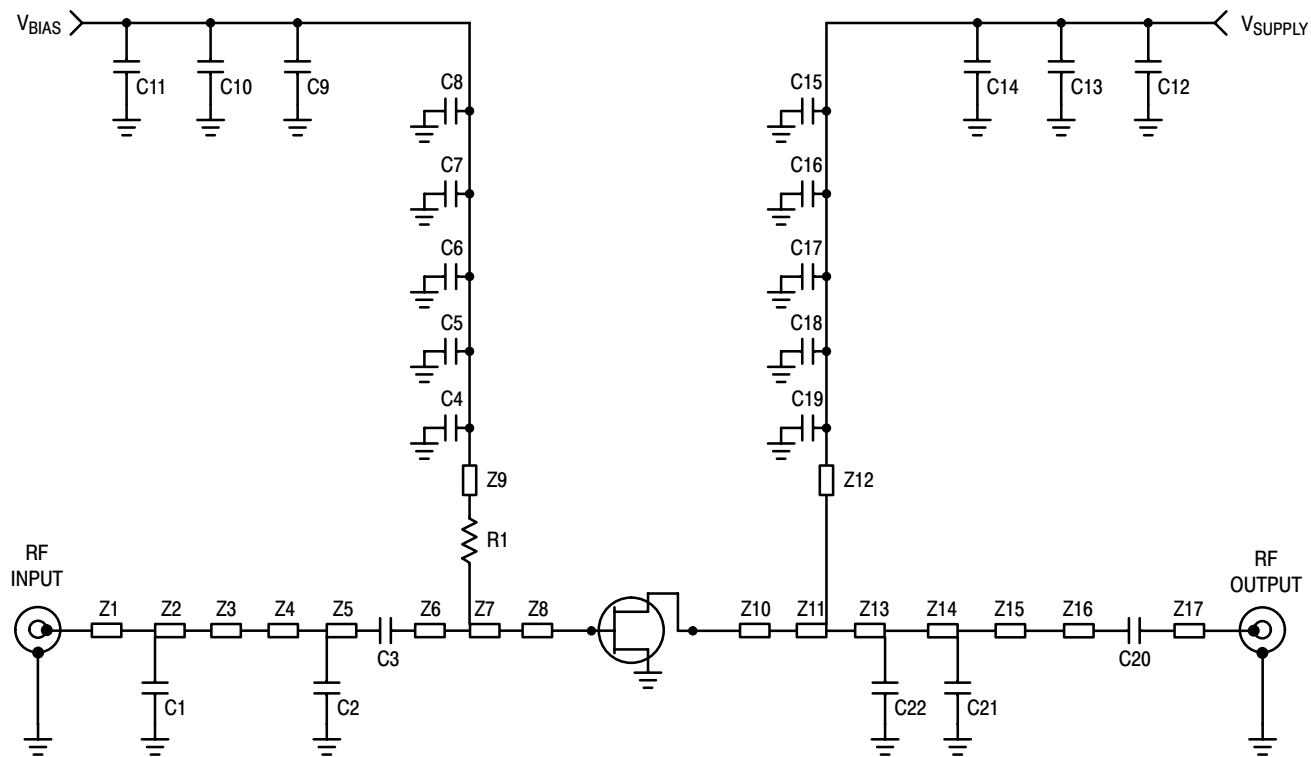
| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------------------------------------------------------------------------------|--------------|------|-------|------|-----------------|
| Saturated Drain Current ($V_{DS} = 3.5\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$) | I_{DSS} | — | 2.9 | — | Adc |
| Off State Leakage Current ($V_{GS} = -0.4\text{ Vdc}$, $V_{DS} = 0\text{ Vdc}$) | I_{GSS} | — | < 1 | 100 | μAdc |
| Off State Drain Current ($V_{DS} = 6\text{ Vdc}$, $V_{GS} = -2.2\text{ Vdc}$) | I_{DSO} | — | 50 | 1000 | μAdc |
| Off State Current ($V_{DS} = 20\text{ Vdc}$, $V_{GS} = -2.5\text{ Vdc}$) | I_{DSX} | — | < 1 | 15 | mAdc |
| Gate-Source Cut-off Voltage ($V_{DS} = 3.5\text{ Vdc}$, $I_{DS} = 15\text{ mA}$) | $V_{GS(th)}$ | -1.2 | -0.95 | -0.7 | Vdc |
| Quiescent Gate Voltage ($V_{DS} = 6\text{ Vdc}$, $I_D = 180\text{ mA}$) | $V_{GS(Q)}$ | -1.1 | -0.82 | -0.6 | Vdc |

Functional Tests (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 6\text{ Vdc}$, $I_{DQ} = 180\text{ mA}$, $P_{out} = 450\text{ mWatts Avg.}$, $f = 3550\text{ MHz}$, Single-Carrier W-CDMA, 3.84 MHz Channel Bandwidth Carrier. ACPR measured in 3.84 MHz Channel Bandwidth @ $\pm 5\text{ MHz}$ Offset. PAR = 8.5 dB @ 0.01% Probability on CCDF.

| | | | | | |
|------------------------------|----------|----|-------|-----|-----|
| Power Gain | G_{ps} | 8 | 10 | — | dB |
| Drain Efficiency | η_D | 22 | 27 | — | % |
| Adjacent Channel Power Ratio | ACPR | — | -42.5 | -38 | dBc |

Typical RF Performance (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 6\text{ Vdc}$, $I_{DQ} = 180\text{ mA}$, $f = 3550\text{ MHz}$

| | | | | | |
|------------------------------------------|-----------|---|---|---|---|
| Output Power, 1 dB Compression Point, CW | P_{1dB} | — | 3 | — | W |
|------------------------------------------|-----------|---|---|---|---|



| | | | |
|---------|----------------------------|-----|-----------------------------------------|
| Z1 | 0.045" x 0.753" Microstrip | Z11 | 0.300" x 0.215" Microstrip |
| Z2, Z4 | 0.045" x 0.025" Microstrip | Z12 | 0.025" x 0.497" Microstrip |
| Z3 | 0.020" x 0.360" Microstrip | Z13 | 0.025" x 0.322" Microstrip |
| Z5 | 0.045" x 0.075" Microstrip | Z14 | 0.025" x 0.270" Microstrip |
| Z6 | 0.045" x 0.055" Microstrip | Z15 | 0.025" x 0.083" Microstrip |
| Z7 | 0.300" x 0.125" Microstrip | Z16 | 0.045" x 0.050" Microstrip |
| Z8, Z10 | 0.146" x 0.070" Microstrip | Z17 | 0.045" x 0.467" Microstrip |
| Z9 | 0.025" x 0.485" Microstrip | PCB | Rogers 4350, 0.020", $\epsilon_r = 3.5$ |

Figure 1. MRFG35003N6A Test Circuit Schematic

Table 6. MRFG35003N6A Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|--------------|----------------------------------|--------------------|--------------|
| C1 | 0.5 pF Chip Capacitor | 08051J0R5BBS | AVX |
| C2 | 0.4 pF Chip Capacitor | 06035J0R4BBS | AVX |
| C3 | 0.5 pF Chip Capacitor | 06035J0R5BBS | AVX |
| C4, C19, C20 | 6.8 pF Chip Capacitors | 08051J6R8BBS | AVX |
| C5, C18 | 10 pF Chip Capacitors | ATC100A100JT150XT | ATC |
| C6, C17 | 100 pF Chip Capacitors | ATC100A101JT150XT | ATC |
| C7, C16 | 100 pF Chip Capacitors | ATC100B101JT500XT | ATC |
| C8, C15 | 1000 pF Chip Capacitors | ATC100B102JT50XT | ATC |
| C9, C14 | 0.01 μ F Chip Capacitors | ATC200B103KT50XT | ATC |
| C10, C13 | 39K pF Chip Capacitors | ATC200B393KT50XT | ATC |
| C11, C12 | 10 μ F, 50 V Chip Capacitors | GRM55DR61H106KA88B | Murata |
| C21, C22 | 0.7 pF Chip Capacitors | 08051J0R7BBS | AVX |
| R1 | 50 Ω Chip Resistor | CRCW040250R0FKTA | Vishay |

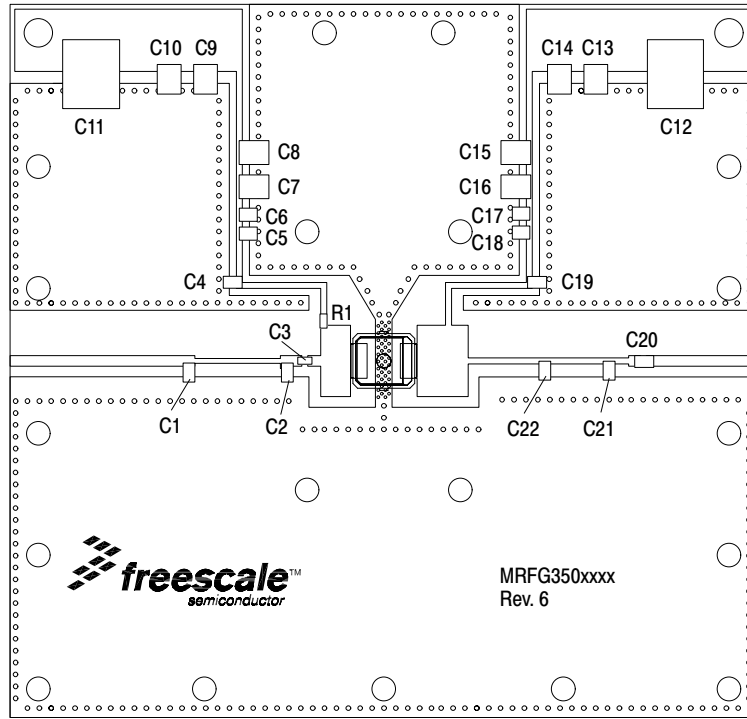


Figure 2. MRFG35003N6A Test Circuit Component Layout

TYPICAL CHARACTERISTICS

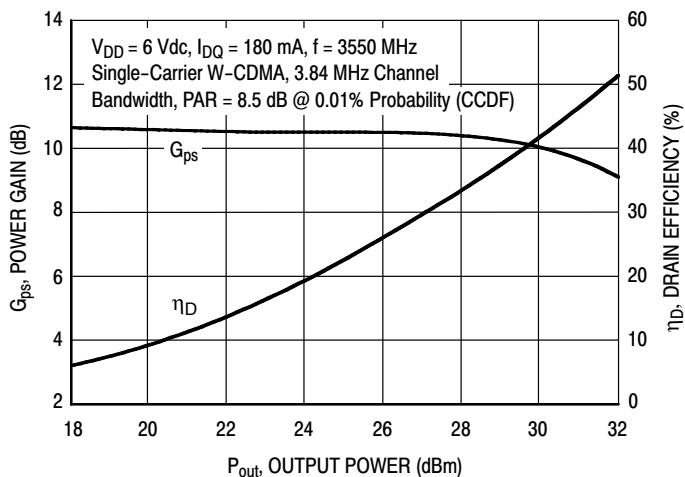


Figure 3. Single-Channel W-CDMA Power Gain and Drain Efficiency versus Output Power

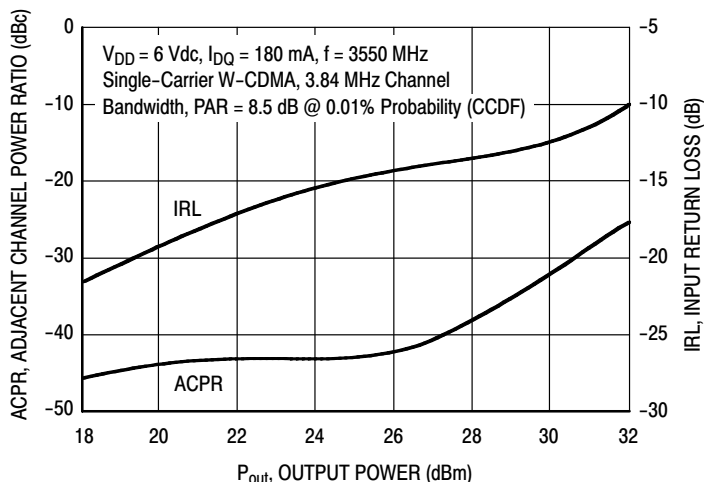


Figure 4. Single-Channel W-CDMA Adjacent Channel Power Ratio and IRL versus Output Power

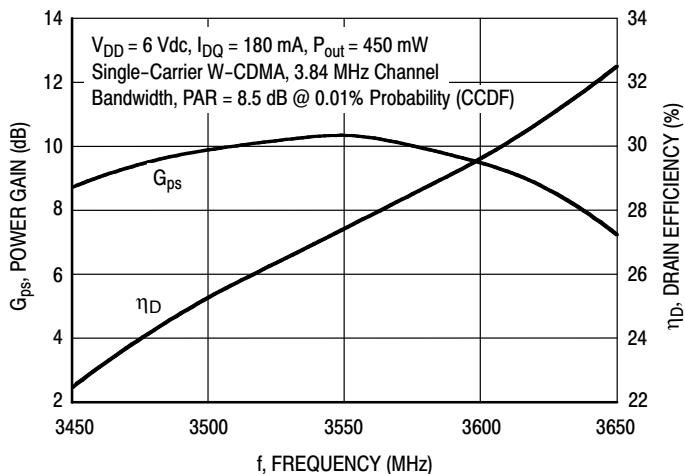


Figure 5. Single-Channel W-CDMA Power Gain and Drain Efficiency versus Frequency

NOTE: Data is generated from the test circuit shown.

TYPICAL CHARACTERISTICS

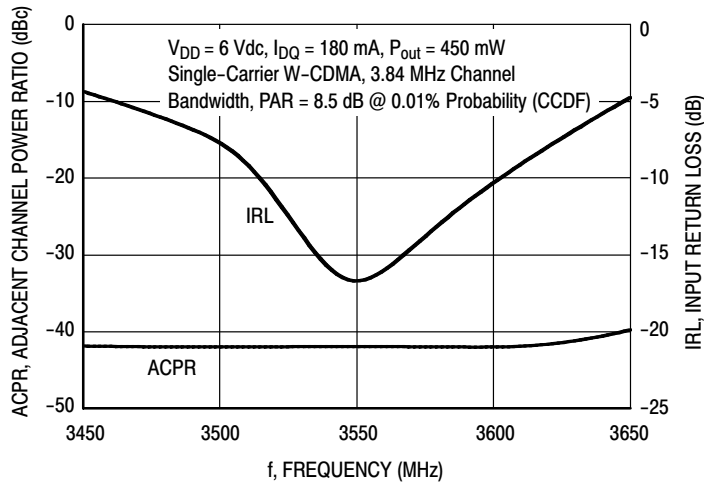


Figure 6. Single-Channel W-CDMA Adjacent Channel Power Ratio and IRL versus Frequency

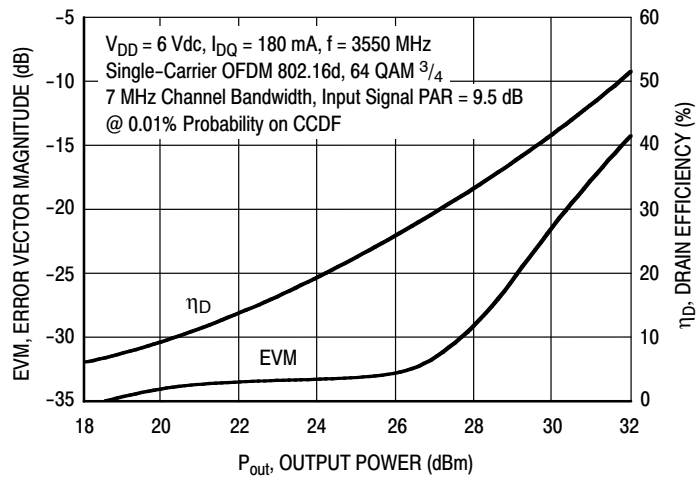


Figure 7. Single-Channel OFDM Error Vector Magnitude and Drain Efficiency versus Output Power

NOTE: Data is generated from the test circuit shown.

Table 7. Common Source S-Parameters ($V_{DD} = 6 \text{ Vdc}$, $I_{DQ} = 180 \text{ mA}$, $T_A = 25^\circ\text{C}$, 50 Ohm System)

| f MHz | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
|----------|-----------------|--------|-----------------|------|-----------------|-------|-----------------|-------|
| | S ₁₁ | ∠φ | S ₂₁ | ∠φ | S ₁₂ | ∠φ | S ₂₂ | ∠φ |
| 500 | 0.952 | -178.5 | 3.658 | 83.3 | 0.017 | 4.87 | 0.844 | 177.9 |
| 550 | 0.952 | -179.7 | 3.336 | 82.0 | 0.017 | 4.61 | 0.845 | 177.3 |
| 600 | 0.952 | 179.2 | 3.062 | 80.7 | 0.017 | 4.46 | 0.845 | 176.8 |
| 650 | 0.952 | 178.2 | 2.832 | 79.4 | 0.018 | 4.25 | 0.845 | 176.2 |
| 700 | 0.952 | 177.2 | 2.627 | 78.2 | 0.018 | 4.15 | 0.845 | 175.7 |
| 750 | 0.952 | 176.3 | 2.451 | 77.0 | 0.018 | 4.03 | 0.844 | 175.1 |
| 800 | 0.952 | 175.4 | 2.304 | 75.8 | 0.018 | 3.89 | 0.844 | 174.6 |
| 850 | 0.952 | 174.6 | 2.175 | 74.7 | 0.018 | 3.79 | 0.845 | 174.1 |
| 900 | 0.952 | 173.9 | 2.062 | 73.5 | 0.018 | 3.72 | 0.845 | 173.6 |
| 950 | 0.952 | 173.1 | 1.955 | 72.4 | 0.018 | 3.66 | 0.845 | 173.1 |
| 1000 | 0.952 | 172.3 | 1.857 | 71.3 | 0.018 | 3.53 | 0.845 | 172.6 |
| 1050 | 0.951 | 171.6 | 1.769 | 70.1 | 0.018 | 3.39 | 0.845 | 172.1 |
| 1100 | 0.951 | 170.9 | 1.696 | 69.0 | 0.018 | 3.25 | 0.845 | 171.6 |
| 1150 | 0.952 | 170.3 | 1.631 | 68.0 | 0.018 | 3.11 | 0.845 | 171.1 |
| 1200 | 0.951 | 169.6 | 1.567 | 66.8 | 0.018 | 2.90 | 0.845 | 170.6 |
| 1250 | 0.951 | 168.9 | 1.508 | 65.8 | 0.018 | 2.78 | 0.845 | 170.0 |
| 1300 | 0.951 | 168.3 | 1.453 | 64.7 | 0.018 | 2.76 | 0.844 | 169.5 |
| 1350 | 0.951 | 167.7 | 1.403 | 63.6 | 0.018 | 2.70 | 0.844 | 168.9 |
| 1400 | 0.951 | 167.1 | 1.360 | 62.5 | 0.019 | 2.56 | 0.843 | 168.4 |
| 1450 | 0.950 | 166.5 | 1.319 | 61.4 | 0.019 | 2.46 | 0.843 | 167.8 |
| 1500 | 0.950 | 166.0 | 1.308 | 60.0 | 0.019 | 2.11 | 0.839 | 166.5 |
| 1550 | 0.950 | 165.7 | 1.267 | 59.0 | 0.019 | 2.15 | 0.839 | 165.8 |
| 1600 | 0.950 | 165.3 | 1.226 | 58.0 | 0.019 | 2.11 | 0.840 | 165.2 |
| 1650 | 0.950 | 164.9 | 1.189 | 57.0 | 0.019 | 2.13 | 0.840 | 164.5 |
| 1700 | 0.950 | 164.4 | 1.154 | 56.0 | 0.019 | 2.02 | 0.841 | 164.0 |
| 1750 | 0.950 | 164.0 | 1.123 | 54.9 | 0.019 | 1.89 | 0.841 | 163.5 |
| 1800 | 0.949 | 163.4 | 1.093 | 53.9 | 0.019 | 1.83 | 0.842 | 163.0 |
| 1850 | 0.949 | 162.9 | 1.065 | 52.9 | 0.020 | 1.75 | 0.842 | 162.6 |
| 1900 | 0.949 | 162.3 | 1.039 | 51.9 | 0.020 | 1.58 | 0.842 | 162.1 |
| 1950 | 0.948 | 161.7 | 1.014 | 50.9 | 0.020 | 1.45 | 0.841 | 161.7 |
| 2000 | 0.948 | 161.1 | 0.991 | 49.9 | 0.020 | 1.27 | 0.841 | 161.3 |
| 2050 | 0.948 | 160.5 | 0.970 | 48.8 | 0.020 | 1.15 | 0.842 | 160.9 |
| 2100 | 0.948 | 159.8 | 0.950 | 47.8 | 0.020 | 0.98 | 0.841 | 160.5 |
| 2150 | 0.947 | 159.2 | 0.931 | 46.8 | 0.020 | 0.83 | 0.841 | 160.1 |
| 2200 | 0.947 | 158.5 | 0.914 | 45.8 | 0.020 | 0.64 | 0.841 | 159.8 |
| 2250 | 0.947 | 157.7 | 0.897 | 44.7 | 0.020 | 0.39 | 0.841 | 159.4 |
| 2300 | 0.947 | 156.9 | 0.883 | 43.6 | 0.021 | 0.13 | 0.839 | 159.1 |
| 2350 | 0.946 | 156.1 | 0.869 | 42.6 | 0.021 | -0.13 | 0.839 | 158.8 |
| 2400 | 0.946 | 155.3 | 0.857 | 41.5 | 0.021 | -0.44 | 0.838 | 158.4 |
| 2450 | 0.945 | 154.4 | 0.845 | 40.4 | 0.021 | -0.82 | 0.838 | 158.1 |
| 2500 | 0.945 | 153.5 | 0.835 | 39.2 | 0.021 | -1.20 | 0.836 | 157.8 |
| 2550 | 0.944 | 152.6 | 0.825 | 38.1 | 0.022 | -1.58 | 0.835 | 157.4 |
| 2600 | 0.944 | 151.7 | 0.816 | 37.0 | 0.022 | -1.95 | 0.833 | 157.0 |
| 2650 | 0.944 | 150.9 | 0.808 | 35.9 | 0.022 | -2.32 | 0.832 | 156.5 |
| 2700 | 0.943 | 150.0 | 0.800 | 34.7 | 0.022 | -2.71 | 0.831 | 156.1 |
| 2750 | 0.942 | 149.0 | 0.793 | 33.5 | 0.023 | -3.10 | 0.830 | 155.6 |

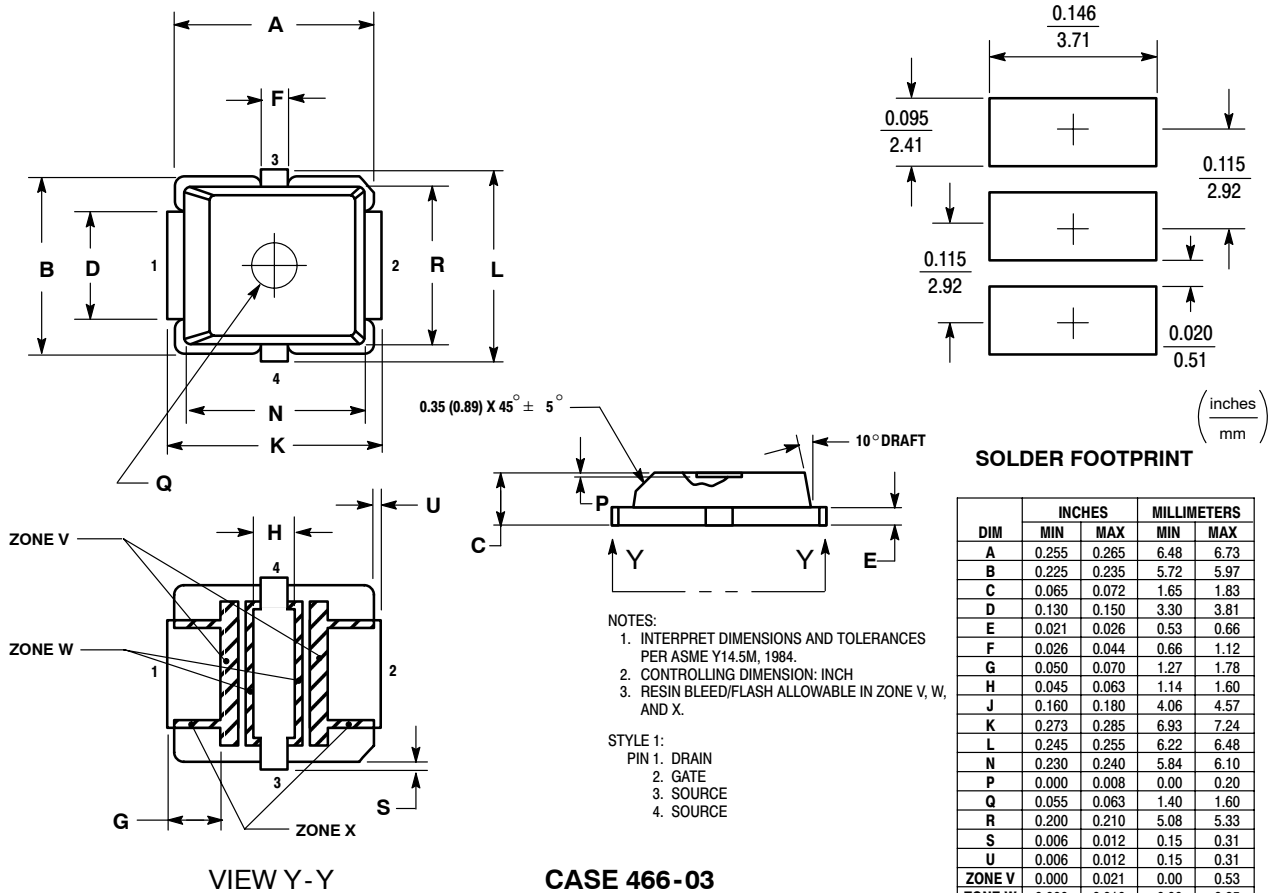
(continued)

MRFG35003N6AT1

Table 7. Common Source S-Parameters ($V_{DD} = 6 \text{ Vdc}$, $I_{DQ} = 180 \text{ mA}$, $T_A = 25^\circ\text{C}$, 50 Ohm System) (continued)

| f MHz | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
|----------|-----------------|-------|-----------------|-------|-----------------|--------|-----------------|-------|
| | S ₁₁ | ∠φ | S ₂₁ | ∠φ | S ₁₂ | ∠φ | S ₂₂ | ∠φ |
| 2800 | 0.942 | 148.1 | 0.787 | 32.3 | 0.023 | -3.45 | 0.828 | 155.1 |
| 2850 | 0.941 | 147.2 | 0.780 | 31.1 | 0.023 | -3.81 | 0.826 | 154.6 |
| 2900 | 0.941 | 146.3 | 0.775 | 29.9 | 0.023 | -4.24 | 0.824 | 154.0 |
| 2950 | 0.940 | 145.4 | 0.770 | 28.6 | 0.024 | -4.68 | 0.822 | 153.3 |
| 3000 | 0.940 | 144.6 | 0.766 | 27.4 | 0.024 | -5.11 | 0.821 | 152.6 |
| 3050 | 0.939 | 143.8 | 0.761 | 26.2 | 0.024 | -5.52 | 0.819 | 151.8 |
| 3100 | 0.938 | 143.0 | 0.757 | 25.0 | 0.025 | -5.90 | 0.818 | 151.0 |
| 3150 | 0.938 | 142.3 | 0.752 | 23.7 | 0.025 | -6.24 | 0.816 | 150.1 |
| 3200 | 0.937 | 141.7 | 0.748 | 22.5 | 0.025 | -6.70 | 0.814 | 149.2 |
| 3250 | 0.937 | 141.1 | 0.745 | 21.3 | 0.026 | -7.22 | 0.813 | 148.2 |
| 3300 | 0.937 | 140.5 | 0.740 | 20.1 | 0.026 | -7.78 | 0.813 | 147.3 |
| 3350 | 0.936 | 139.9 | 0.736 | 18.9 | 0.027 | -8.32 | 0.811 | 146.3 |
| 3400 | 0.935 | 139.3 | 0.732 | 17.7 | 0.027 | -8.86 | 0.810 | 145.4 |
| 3450 | 0.934 | 138.8 | 0.728 | 16.5 | 0.027 | -9.47 | 0.809 | 144.5 |
| 3500 | 0.934 | 138.2 | 0.723 | 15.3 | 0.028 | -10.00 | 0.808 | 143.6 |
| 3550 | 0.933 | 137.6 | 0.720 | 14.1 | 0.028 | -10.60 | 0.807 | 142.7 |
| 3600 | 0.932 | 137.0 | 0.716 | 13.0 | 0.028 | -11.16 | 0.807 | 141.9 |
| 3650 | 0.932 | 136.4 | 0.712 | 11.8 | 0.028 | -11.65 | 0.807 | 141.1 |
| 3700 | 0.930 | 135.8 | 0.708 | 10.7 | 0.029 | -12.05 | 0.807 | 140.3 |
| 3750 | 0.929 | 135.1 | 0.704 | 9.6 | 0.029 | -12.48 | 0.806 | 139.6 |
| 3800 | 0.928 | 134.5 | 0.700 | 8.5 | 0.029 | -12.78 | 0.806 | 138.9 |
| 3850 | 0.928 | 133.9 | 0.696 | 7.4 | 0.029 | -13.03 | 0.805 | 138.3 |
| 3900 | 0.927 | 133.2 | 0.693 | 6.3 | 0.030 | -13.30 | 0.804 | 137.6 |
| 3950 | 0.926 | 132.6 | 0.690 | 5.2 | 0.030 | -13.55 | 0.804 | 137.0 |
| 4000 | 0.926 | 131.8 | 0.687 | 4.1 | 0.030 | -13.84 | 0.802 | 136.4 |
| 4050 | 0.925 | 131.1 | 0.684 | 3.1 | 0.030 | -14.13 | 0.801 | 135.8 |
| 4100 | 0.924 | 130.4 | 0.681 | 1.9 | 0.031 | -14.34 | 0.799 | 135.1 |
| 4150 | 0.923 | 129.7 | 0.679 | 0.8 | 0.031 | -14.45 | 0.798 | 134.5 |
| 4200 | 0.921 | 128.9 | 0.677 | -0.2 | 0.031 | -14.48 | 0.797 | 134.0 |
| 4250 | 0.920 | 128.1 | 0.676 | -1.4 | 0.032 | -14.65 | 0.797 | 133.4 |
| 4300 | 0.917 | 127.2 | 0.675 | -2.5 | 0.032 | -14.76 | 0.796 | 132.9 |
| 4350 | 0.917 | 126.3 | 0.674 | -3.7 | 0.033 | -15.08 | 0.795 | 132.3 |
| 4400 | 0.916 | 125.4 | 0.673 | -4.9 | 0.034 | -15.50 | 0.792 | 131.8 |
| 4450 | 0.915 | 124.3 | 0.673 | -6.1 | 0.034 | -15.93 | 0.791 | 131.3 |
| 4500 | 0.913 | 123.2 | 0.673 | -7.4 | 0.035 | -16.40 | 0.788 | 130.8 |
| 4550 | 0.912 | 122.0 | 0.673 | -8.7 | 0.035 | -16.94 | 0.786 | 130.2 |
| 4600 | 0.910 | 120.7 | 0.674 | -10.0 | 0.036 | -17.54 | 0.783 | 129.7 |
| 4650 | 0.909 | 119.4 | 0.675 | -11.4 | 0.037 | -18.24 | 0.780 | 129.1 |
| 4700 | 0.908 | 118.0 | 0.676 | -12.8 | 0.038 | -18.93 | 0.777 | 128.6 |
| 4750 | 0.907 | 116.5 | 0.679 | -14.3 | 0.038 | -19.78 | 0.773 | 127.9 |
| 4800 | 0.905 | 115.0 | 0.681 | -15.9 | 0.039 | -20.65 | 0.771 | 127.2 |
| 4850 | 0.903 | 113.4 | 0.684 | -17.4 | 0.040 | -21.58 | 0.768 | 126.4 |
| 4900 | 0.901 | 111.8 | 0.686 | -19.1 | 0.041 | -22.66 | 0.765 | 125.6 |
| 4950 | 0.900 | 110.2 | 0.689 | -20.7 | 0.042 | -23.74 | 0.762 | 124.6 |
| 5000 | 0.898 | 108.6 | 0.692 | -22.4 | 0.042 | -24.86 | 0.757 | 123.6 |

PACKAGE DIMENSIONS



**CASE 466-03
ISSUE D
PLD-1.5
PLASTIC**

MRFG35003N6AT1

PRODUCT DOCUMENTATION

Refer to the following documents to aid your design process.

Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date | Description |
|----------|-----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0 | July 2007 | <ul style="list-style-type: none">• Initial Release of Data Sheet |
| 1 | Nov. 2008 | <ul style="list-style-type: none">• Removed "Operating Case Temperature Range" from Maximum Ratings table so that the maximum channel temperature rating is the limiting thermal design criteria and not the case temperature range, p. 1 |
| 2 | June 2009 | <ul style="list-style-type: none">• Modified data sheet to reflect MSL rating change from 1 to 3 as a result of the standardization of packing process as described in Product and Process Change Notification number, PCN13516, p. 1 |

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